



RoHS Compliant

**MAX
260°C**

**MSL
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit	ppm
753 12 SRT							134.60	
Alumina Ceramic	Al2O3	1344-28-1	0.8800	0.1184	87.50%	103.6420	77.00%	770000
	SiO2 (silicon dioxide)	14808-60-7			12.50%	14.8060	11.00%	110000
					100.00%	118.4480		
Conductor Thick Film	Ag	7440-22-4	0.0068	0.0009	100.00%	0.9153	0.68%	6800
					100.00%	0.9153		
Resistor Thick Film	RuO2	12036-10-1	0.0079	0.0011	30.00%	0.3190	0.24%	2370
	PbO	1317-36-8			10.00%	0.1063	0.08%	790
	SiO2 (silicon dioxide)	14808-60-7			30.00%	0.3190	0.24%	2370
	B2O3	1303-86-2			30.00%	0.3190	0.24%	2370
					100.00%	1.0633		
Notch Conductor Thick Film	Ag	7440-22-4	0.0113	0.0015	100.00%	1.5210	1.13%	11300
					100.00%	1.5210		
Underplate	Ni	7440-02-0	0.0250	0.0034	100.00%	3.3650	2.50%	25000
Finish Plate	Sn	7440-31-5	0.0170	0.0023	100.00%	2.2882	1.70%	17000
					100.00%	2.2882		
Covercoat	TiO2 Silicone	13463-67-7	0.0520	0.0070	50.00%	3.4996	2.60%	26000
		218163-11-2			50.00%	3.4996	2.60%	26000
		Sum			100.00%	6.9992		
			1.0000 part weight	0.1346 0.1346				
		Totals:		0.1346		134.60	100.00%	1000000

RoHS exemption claimed for lead in glass of electronic component